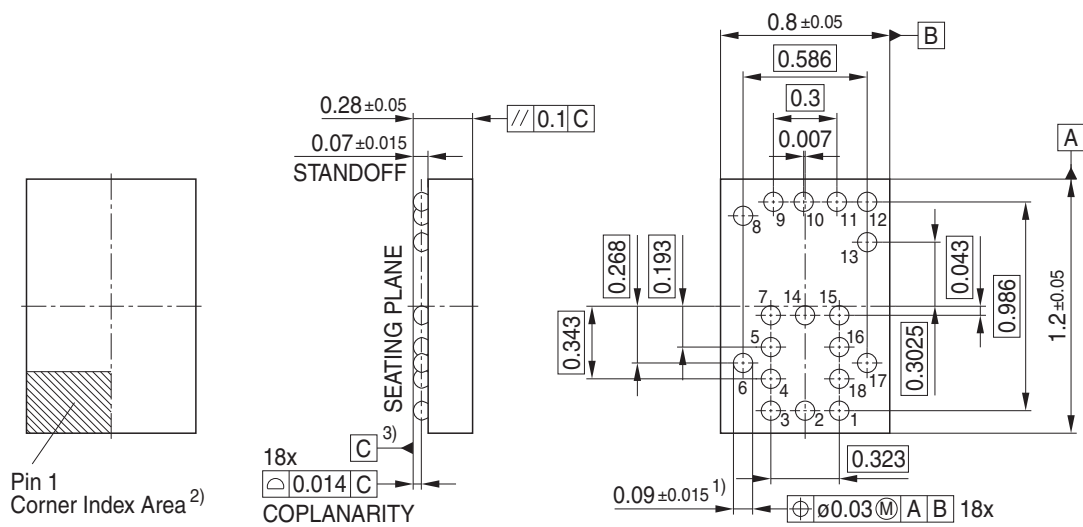


Package Outline



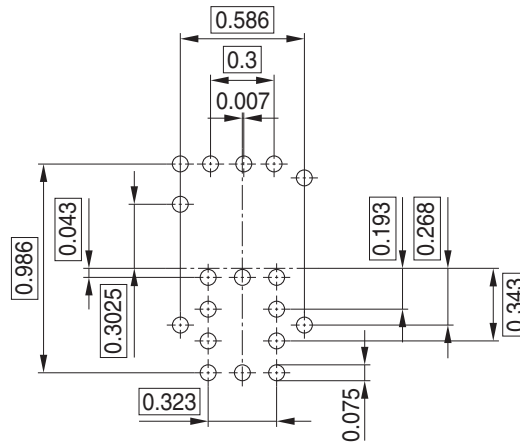
1) Dimension is measured at the maximum solder ball diameter, parallel to primary datum C

2) Pin 1 corner identified by marking

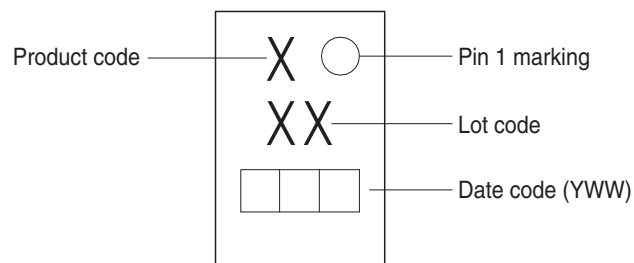
3) Primary datum C and seating plane are defined by the domed crowns of the balls

Foot Print

Soldering Type: Reflow Soldering



Marking Layout



Tape and Reel

Reel ϕ 180 mm: 14.000 Pieces/Reel

Reels/Box: 1

